

# Addendum to MC68HC705J1A HCMOS Microcontroller Unit Technical Data

This addendum provides changes to the *MC68HC705J1A*, *MC68HRC705J1A*, *MC68HSC705J1A*, and *MC68HSR705J1A Technical Data* (Motorola document order number MC68HC705J1A/D Rev. 3.0).

On page 35, change the last entry of **Figure 2-2. I/O Register Summary**

From:

Addr.	Register Name	Bit 7	6	5	4	3	2	1	Bit 0	
\$07F1	Mask Option Register (MOR) See page 39.	Read:	SOSCD	EPMSEC	OSCRE	SWAIT	SWPDI	PIRQ	LEVEL	COPEN
		Write:								
		Reset:	0	0	0	0	0	0	0	0

To:

Addr.	Register Name	Bit 7	6	5	4	3	2	1	Bit 0	
\$07F1	Mask Option Register (MOR) See page 39.	Read:	SOSCD	EPMSEC	OSCRE	SWAIT	SWPDI	PIRQ	LEVEL	COPEN
		Write:								
		Reset:	Unaffected by reset							



**Addendum**

On page 39, change **Figure 2-4. Mask Option Register (MOR)**

From:

Address: \$07F1

	Bit 7	6	5	4	3	2	1	Bit 0
Read:	SOSCD	EPMSEC	OSCRE	SWAIT	SWPDI	PIRQ	LEVEL	COPEN
Write:								
Reset:	0	0	0	0	0	0	0	0

**Figure 2-4. Mask Option Register (MOR)**

To:

Address: \$07F1

	Bit 7	6	5	4	3	2	1	Bit 0
Read:	SOSCD	EPMSEC	OSCRE	SWAIT	SWPDI	PIRQ	LEVEL	COPEN
Write:								
Reset:	Unaffected by reset							

**Figure 2-4. Mask Option Register (MOR)**

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On page 89, change the note under **6.3.3 Pulldown Register A**:

From:

**NOTE:** *If the SWPDI bit in the mask option register is programmed to logic 1, reset initializes all port A pins as inputs with enabled pulldown devices.*

To:

**NOTE:** *If the SWPDI bit in the mask option register is programmed to logic 1, reset initializes all port A pins as inputs with disabled pulldown devices.*

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On page 92, change the note under **6.4.3 Pulldown Register B**

From:

**NOTE:** *If the SWPDI bit in the mask option register is programmed to logic 1, reset initializes all port B pins as inputs with enabled pulldown devices.*

To:

**NOTE:** *If the SWPDI bit in the mask option register is programmed to logic 1, reset initializes all port B pins as inputs with disabled pulldown devices.*

## Addendum

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